CONNECTORS J1, AND J4 ARE MIRRORED. WHEN THE SAME CONNECTOR IS USED ON BOTH END A AND END B THE PIN 1 DOES NOT ALIGN. SO WE MIRROR ON THIS SCHEMATIC SO THAT CONNECTOR PIN 1 MATCHES THE CONNECTOR. J3 IS NOT MIRRORED AS IT IS MIRRORED ON THE LCD PANEL.

FOR 24 BIT DISPLAY DIRECT MAP.
FOR 18 BIT DISPLAY SHFT DOWN 2 BITS.

TO BEZEL

TO J5/J6 EVM

Mounting holes 0.250 pad 0.125 drill
Mounting holes 0.250 pad 0.125 drill
Mounting holes 0.250 pad 0.125 drill

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